

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/559923	Confirmation No.	1496
Applicant	:	Yoshinari Tsukada et al.		
Filed	:	December 8, 2005		
TC/A.U.	:	2826		
Examiner	:	Alexander O. Williams		
Title	:	SEMICONDUCTOR DEVICE REDUCING WARPING DUE TO HEAT PRODUCTION (as amended)		
Docket No.	:	SHM-16366		
Customer No.	:	040854		

AMENDMENT "C"

(In response to Paper No./Mail Date 20080606)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is filed in response to the Office action dated June 9, 2008. The three month period for responding to the Office action expires on September 9, 2008. Please amend the above-identified application as follows:

- **Amendments to the Claims** are reflected in the listing of claims, which begins on page 2 of this paper.
- **Remarks/Arguments** begin on page 8 of this paper.